

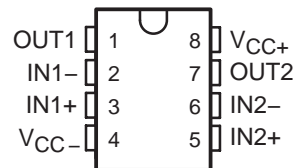
TL3414A

DUAL HIGH-OUTPUT-CURRENT OPERATIONAL AMPLIFIER

SLOS453A – DECEMBER 2004 – REVISED JANUARY 2005

- Single/Dual Power-Supply Operation
- High Output Current . . . 70 mA, $V_{CC+} = 5\text{ V}$
- Wide Operating Voltage . . . 3 V to 15 V (Single Supply)
- Ideal for Headphone Drivers

D (SOIC), P (PDIP), OR PW (TSSOP) PACKAGE
(TOP VIEW)



description/ordering information

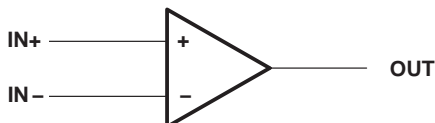
The TL3414A device is a dual operational amplifier that can be operated with single or dual power supplies. In addition to high gain and high output voltage swing, it is capable of driving a 70-mA load, making it ideally suited for simple, low-cost audio-amplifier applications, such as headphone amplifiers in DVD and CDRW applications.

ORDERING INFORMATION

| T _A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------|--------------|-----------------------|------------------|
| -40°C to 85°C | PDIP (P) | Tube of 50 | TL3414AIP | TL3414AIP |
| | SOIC (D) | Tube of 75 | TL3414AID | Z3414A |
| | | Reel of 2500 | TL3414AIDR | |
| | TSSOP (PW) | Tube of 150 | TL3414AIPW | Z3414A |
| | | Reel of 2000 | TL3414AIPWR | |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

symbol (each amplifier)



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

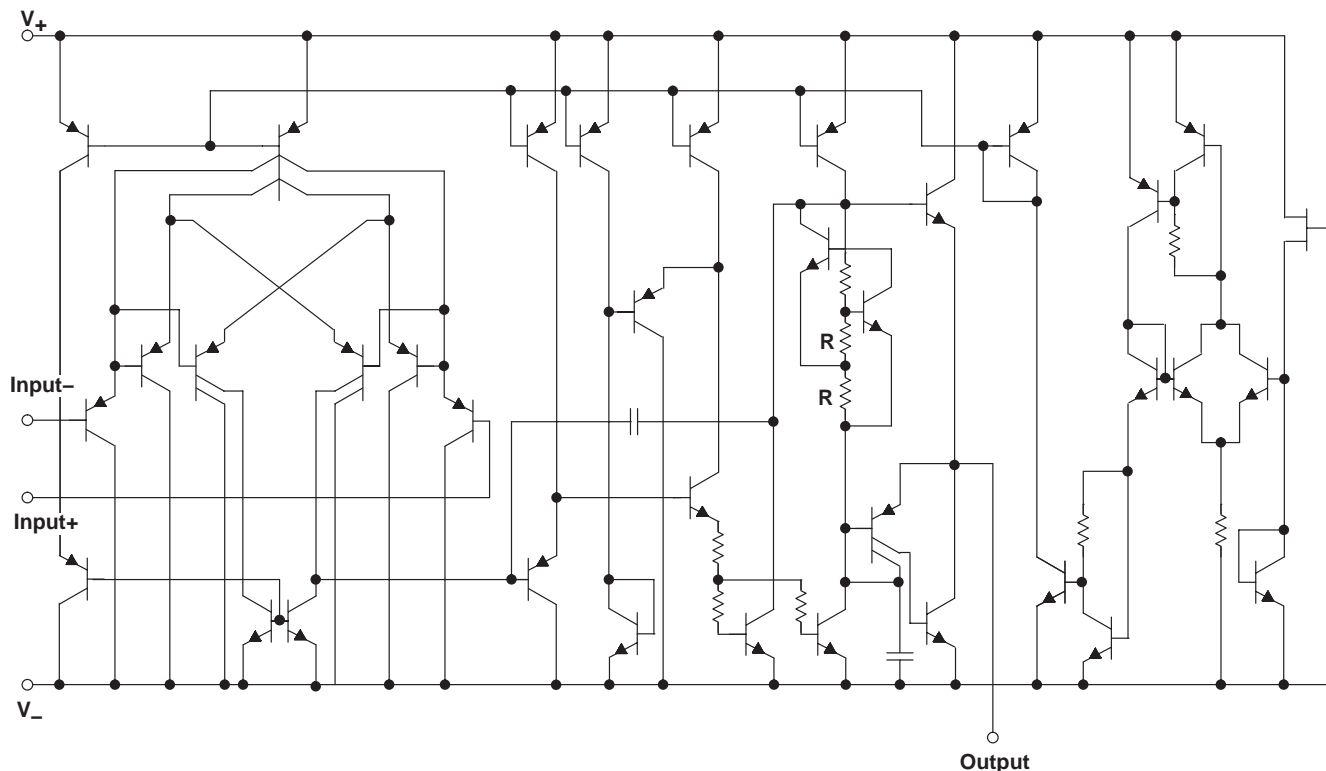
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TL3414A DUAL HIGH-OUTPUT-CURRENT OPERATIONAL AMPLIFIER

SLOS453A – DECEMBER 2004 – REVISED JANUARY 2005

simplified schematic



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|---|------------------------|
| Supply voltage, V_{CC+} (single supply) | 15 V |
| Supply voltage, V_{CC-} (single supply) | 0 V |
| Supply voltage, V_{CC+} (dual supply) | 7.5 V |
| Supply voltage, V_{CC-} (dual supply) | -7.5 V |
| Supply voltage, (V_{CC-} to V_{CC+}) | 15 V |
| Input voltage, either input (see Note 1) | V_{CC-} or V_{CC+} |
| Input current (see Note 2) | ± 10 mA |
| Duration of output short circuit (see Note 3) | Unlimited |
| Package thermal impedance, θ_{JA} (see Notes 4 and 5): D package | 97°C/W |
| P package | 85°C/W |
| PW package | 149°C/W |
| Operating virtual junction temperature, T_J | 150°C |
| Storage temperature range, T_{stg} | -40°C to 125°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The magnitude of the input voltage must never exceed the magnitude of the supply voltage.
 2. Excessive input current will flow if a differential input voltage in excess of approximately 0.6 V is applied between the inputs, unless some limiting resistance is used.
 3. The output may be shorted to ground or either power supply. Temperature and/or supply voltages must be limited to ensure the maximum dissipation rating is not exceeded.
 4. Maximum power dissipation is a function of $T_J(\max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
 5. The package thermal impedance is calculated in accordance with JESD 51-7.



TL3414A

DUAL HIGH-OUTPUT-CURRENT OPERATIONAL AMPLIFIER

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recommended operating conditions

| | | MIN | MAX | UNIT |
|-----------|--------------------------------------|------|------|------|
| V_{CC} | Supply voltage (single supply) | 3 | 15 | V |
| V_{CC+} | Supply voltage (dual supply) | 1.5 | 7.5 | V |
| V_{CC-} | Supply voltage (dual supply) | -1.5 | -7.5 | V |
| V_{ID} | Differential input voltage | | 15 | V |
| V_I | Input voltage | -0.3 | 15 | V |
| T_A | Operating free-air temperature range | -40 | 85 | °C |

DC electrical characteristics, $V_{CC+} = 5\text{ V}$, $V_{CC-} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
|-------------------|---|--|------------------------|-----|------|----|
| V_{IO} | Input offset voltage $R_S = 0\ \Omega$ | | 2 | 5 | mV | |
| I_{IO} | Input offset current | | 15 | 100 | nA | |
| I_{IB} | Input bias current | | 300 | 600 | nA | |
| A_{VD} | Large-signal differential voltage amplification $R_L = 2\ \text{k}\Omega$ | | 77 | 100 | dB | |
| V_{ICR} | Common-mode input voltage range | | $V_{CC+} - 2\text{ V}$ | | V | |
| V_{OM} | Output voltage swing $R_L > 2\ \text{k}\Omega$, $V_{CC+} = 5\text{ V}$ | | 3.5 | | V | |
| | | $I_O = 70\ \text{mA}$, $V_{CC+} = 5\text{ V}$ | 3.2 | | | |
| CMRR | Common-mode rejection ratio | | 70 | 79 | dB | |
| k_{SVR}^\dagger | Supply-voltage rejection ratio | | 80 | 90 | dB | |
| I_{CC} | Supply current (all amplifiers) $R_L = \text{open circuit}$ (full temperature range) | | 3 | 4 | 6 | mA |

† Measured with $V_{CC\pm}$ differentially and simultaneously varied from 5 V to 8.6 V

AC electrical characteristics, $V_{CC+} = 5\text{ V}$, $V_{CC-} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|-----------|---|------|------------------------|
| SR | Slew rate at unity gain | 0.83 | V/ μs |
| GBW | Gain bandwidth product | 1.1 | MHz |
| V_n | Equivalent input noise voltage $f = 1\ \text{kHz}$ | 18 | nV/ $\sqrt{\text{Hz}}$ |

DC electrical characteristics, $V_{CC+} = 8.6\text{ V}$, $V_{CC-} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT | |
|-------------------|---|--|------------------------|-----|------|----|
| V_{IO} | Input offset voltage $R_S = 0\ \Omega$ | | 2 | 5 | mV | |
| I_{IO} | Input offset current | | 15 | 100 | nA | |
| I_{IB} | Input bias current | | 300 | 600 | nA | |
| A_{VD} | Large-signal differential voltage amplification $R_L = 2\ \text{k}\Omega$ | | 88 | 105 | dB | |
| V_{ICR} | Common-mode input voltage range | | $V_{CC+} - 2\text{ V}$ | | V | |
| V_{OM} | Output voltage swing $R_L > 2\ \text{k}\Omega$, $V_{CC+} = 8.6\text{ V}$ | | 7 | | V | |
| | | $I_O = 70\ \text{mA}$, $V_{CC+} = 8.6\text{ V}$ | 6.7 | | | |
| CMRR | Common-mode rejection ratio | | 80 | 90 | dB | |
| k_{SVR}^\dagger | Supply-voltage rejection ratio | | 80 | 90 | dB | |
| I_{CC} | Supply current (all amplifiers) $R_L = \text{open circuit}$ (full temperature range) | | 3 | 4 | 6 | mA |

† Measured with $V_{CC\pm}$ differentially and simultaneously varied from 5 V to 8.6 V



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AC electrical characteristics, $V_{CC+} = 8.6\text{ V}$, $V_{CC-} = 0\text{ V}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|--------------------------------|--------------------|-----|------------------------------|
| SR | Slew rate at unity gain | | 1.3 | V/ μs |
| GBW | Gain bandwidth product | | 2 | MHz |
| V_n | Equivalent input noise voltage | $f = 1\text{ kHz}$ | 18 | $\text{nV}/\sqrt{\text{Hz}}$ |

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TL3414AID | Active | Production | SOIC (D) 8 | 75 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z3414A |
| TL3414AID.A | Active | Production | SOIC (D) 8 | 75 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z3414A |
| TL3414AIDR | Active | Production | SOIC (D) 8 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z3414A |
| TL3414AIDR.A | Active | Production | SOIC (D) 8 | 2500 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z3414A |
| TL3414AIPW | Active | Production | TSSOP (PW) 8 | 150 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z3414A |
| TL3414AIPW.A | Active | Production | TSSOP (PW) 8 | 150 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z3414A |
| TL3414AIPWR | Active | Production | TSSOP (PW) 8 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z3414A |
| TL3414AIPWR.A | Active | Production | TSSOP (PW) 8 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z3414A |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

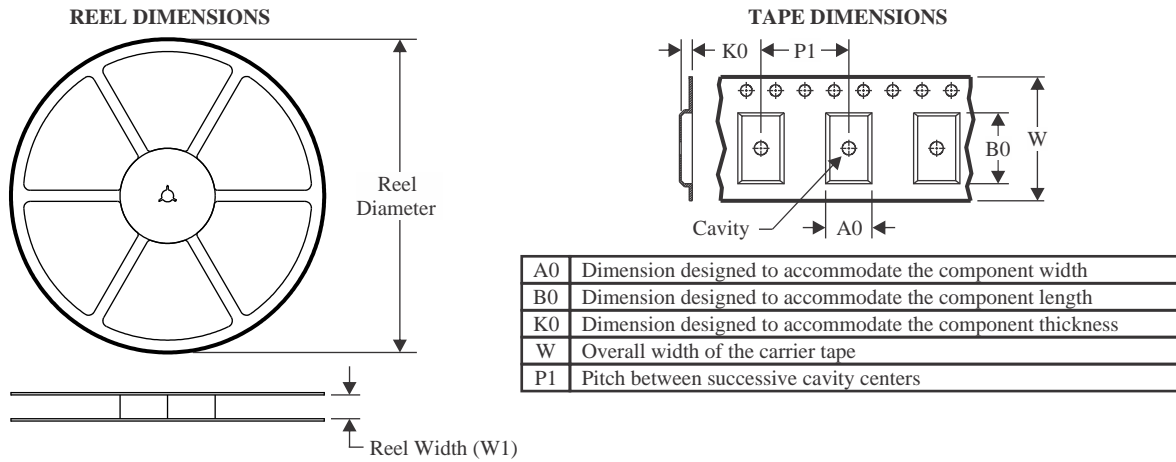
(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TL3414AIDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| TL3414AIPWR | TSSOP | PW | 8 | 2000 | 330.0 | 12.4 | 7.0 | 3.6 | 1.6 | 8.0 | 12.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL3414AIDR | SOIC | D | 8 | 2500 | 340.5 | 338.1 | 20.6 |
| TL3414AIPWR | TSSOP | PW | 8 | 2000 | 353.0 | 353.0 | 32.0 |

TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TL3414AID | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| TL3414AID.A | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| TL3414AIPW | PW | TSSOP | 8 | 150 | 530 | 10.2 | 3600 | 3.5 |
| TL3414AIPW.A | PW | TSSOP | 8 | 150 | 530 | 10.2 | 3600 | 3.5 |



D0008A

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

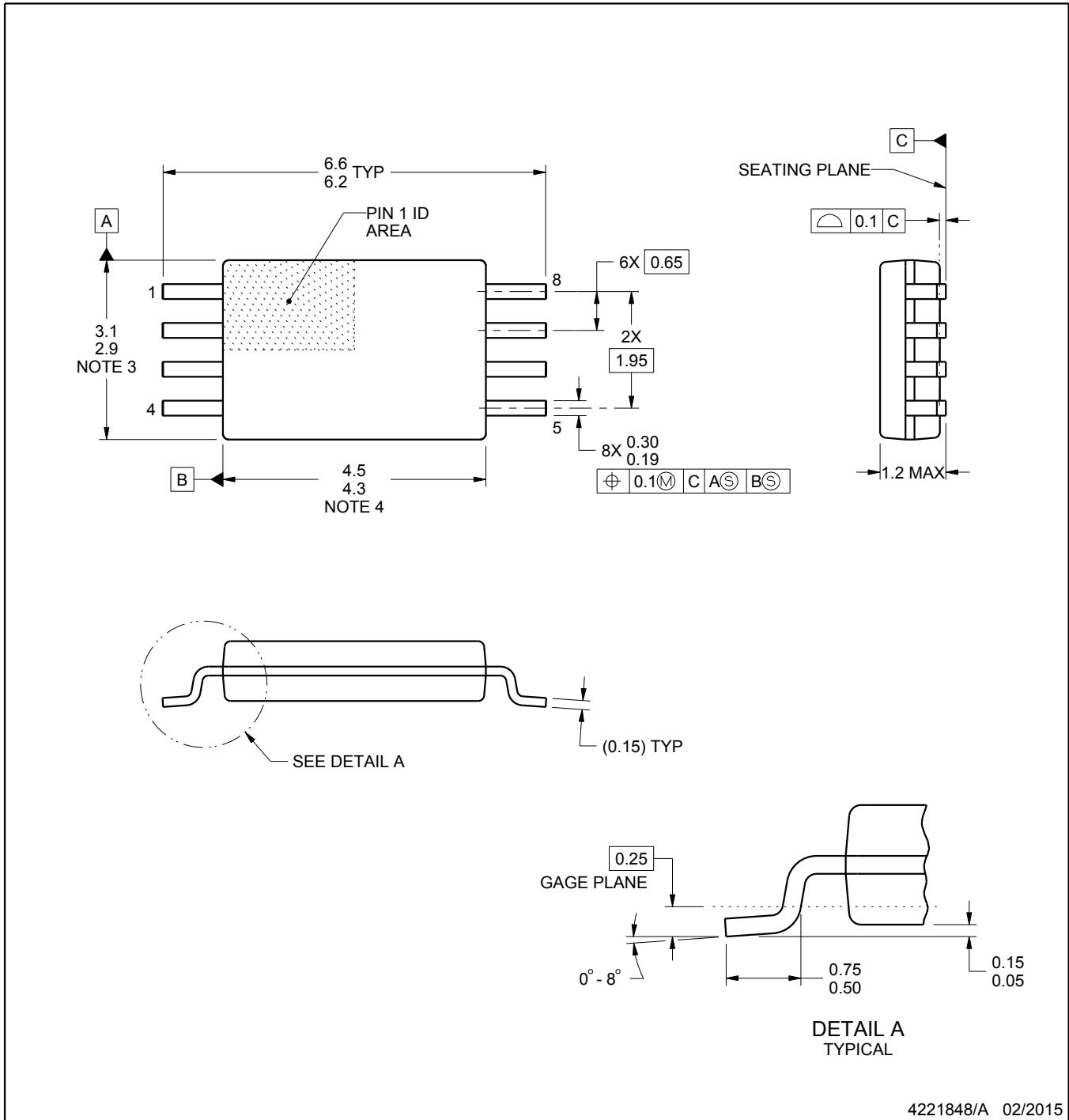
PW0008A



PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



4221848/A 02/2015

NOTES:

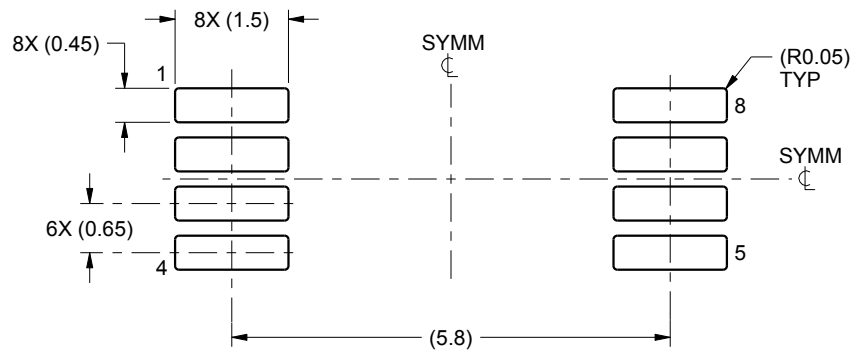
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- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- Reference JEDEC registration MO-153, variation AA.

EXAMPLE BOARD LAYOUT

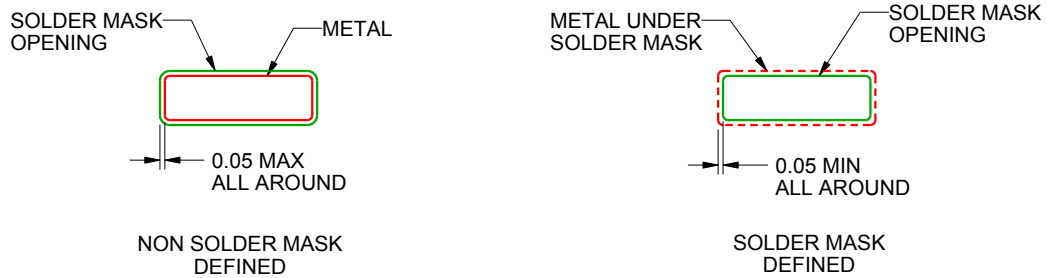
PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:10X



SOLDER MASK DETAILS
NOT TO SCALE

4221848/A 02/2015

NOTES: (continued)

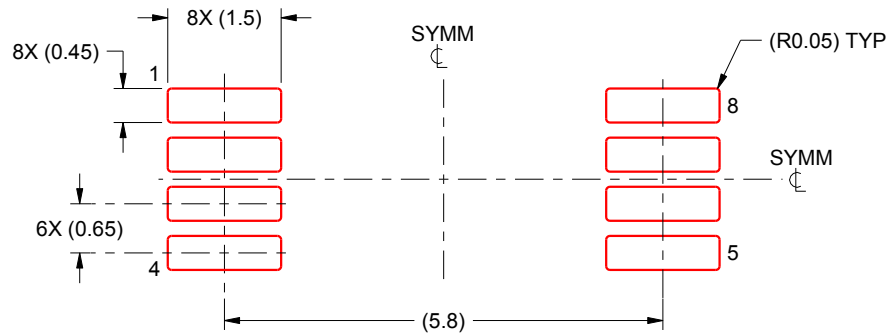
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0008A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:10X

4221848/A 02/2015

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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